

1. ALL RESISTANCE VALUES ARE IN OHMS, 0.1 WATT +/- 5%.
2. ALL CAPACITANCE VALUES ARE IN MICROFARADS.
3. ALL CRYSTALS & OSCILLATOR VALUES ARE IN HERTZ.

REV	ZONE	ECN	DESCRIPTION OF CHANGE	CK APPD DATE	ENG APPD DATE
03		437070	ENGINEERING RELEASED	04/27/06	?

M51 HEATSINK AND AMBIENT TEMP SENSOR BOARDS

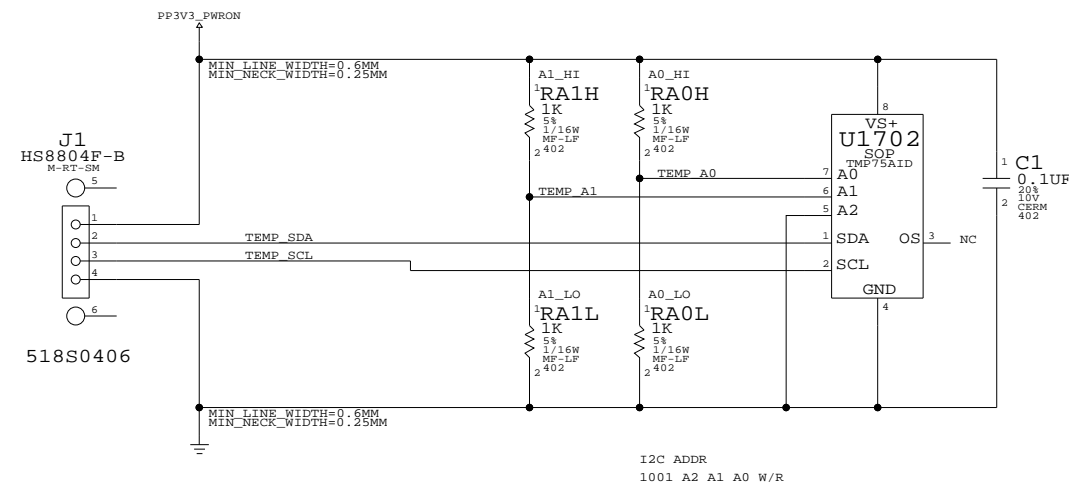
04/27/06

BOM NUMBER	BOM NAME	BOM OPTIONS
630-7602	HEATSINK_TEMP, M51	COMMON, ALTERNATE, HSK, ADDR_94
630-7603	AMBIENT_TEMP, M51	COMMON, AMB, ADDR_96

BOM GROUP	BOM OPTIONS
ADDR_90	A1_LO, A0_LO
ADDR_92	A1_LO, A0_HI
ADDR_94	A1_HI, A0_LO
ADDR_96	A1_HI, A0_HI

PART#	QTY	DESCRIPTION	REFERENCE DESIGNATOR(S)	CRITICAL	BOM OPTION
051-7127	1	SCH, HSK_AMB_TSENSE, M51	SCH1		
820-2035	1	PCB, HSK TEMP SENSOR, M51	PCB1		HSK
820-2036	1	PCB, AMB TEMP SENSOR, M51	PCB1		AMB
946-0709	1	THERMAL TAPE, M51	ADH1		HSK
946-0713	1	ADHESIVE, M51 AMB TEMP	ADH1		AMB

PART NUMBER	ALTERNATE FOR PART NUMBER	BOM OPTION	REF DES	COMMENTS:
820-2058	820-2035		ALL	2-LAYER VERSION



DIMENSIONS ARE IN MILLIMETERS		METRIC		Apple Computer Inc.	
XX :	_____	DRAPTR	/	DESIGN CK	/
X.XX :	_____	ENG APPD	/	MFG APPD	/
X.XXX :	_____	QA APPD	/	DESIGNER	/
ANGLES :	_____	RELEASE	/	SCALE	NONE
DO NOT SCALE DRAWING		MATERIAL/FINISH NOTED AS APPLICABLE		SIZE	D
 THIRD ANGLE PROJECTION				TITLE SCH, HSK_AMB_TSENSE, M51	
				DRAWING NUMBER	051-7127
				REV.	03
				SHT 1 OF 1	